	CONNECTING CS INDUSTRIES International and Par	PC, Bannockb	ourn, Illinois. A	All rights reserved u ntions.	nder both	This docume level parts, th	ent is a declarat he declaration	tion of t encomp	the substances basses all low	s within the er level mat	manufactur erials for wl	er listed it hich the m	em. Note: it anufacturer	f the item is an as has engineering	sembly with lowe responsibility.
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information					
Supplie	r Information														
Company name* Company u				unique ID			Unique ID Authority					Response Date*			
nsemi												2023-06-08			
Contact N	lame		Title - Contact]	Phone - Contact*				Email - Contact*				
Product-l	Env-Stewards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
uthorize	ed Representative*		Title - Representative]	Phone - Representative*				Email - Representative*				
Product-l	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
			Number Mfr Item Name				Effective Date	ate Version Manufacturing Site		ring Site	١	Weight*	UOM	Unit Type	
			ANA 1A 5V VREG		2023-06-08	2023-06-08		CNC		1	365.61	mg	Each		
/Ianufa	cturing Proccess Informa	tion													
	Terminal Plating / Grid Array Material		Ferminal Base Alloy J-STD-020 M		-STD-020 MS	L Rating	Peak Process Body Temperat		ure Max Time at Peak Ter		Temperat	ure Numb	er of Reflow Cyc	les	
Matte Tin (Sn) - annealed		CU Alloy NA			0 C		30		secon	ds 3					
omments	3														
or more	information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		mium (Cr6+), Polybrominated Biphenyls (Pl		dmium and quantity limit of 0.1% by mass (10 minated Diphenyl Ethers (PBDE), and Bis(2-et	
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).		
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the
Supplier Digital Signature	astislav Drska	Le			

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

sigma range of distribution unless otherwise noted).										
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure		
Die	1.61	mg	Supplier	Silicon (Si)	7440-21-3		1.61	mg		
Die Attach	0.21	mg	А	Lead (Pb)	7439-92-1	7a	0.189	mg		
			Supplier	Tin (Sn)	7440-31-5		0.021	mg		
Lead Frame	677.24	mg	Supplier	Silver (Ag)	7440-22-4		0.0339	mg		
			Supplier	Iron (Fe)	7439-89-6		0.6772	mg		
			Supplier	Copper (Cu)	7440-50-8		676.3054	mg		
			Supplier	Phosphorus (P)	7723-14-0		0.2235	mg		
Mold Compound-Black	644.0	mg		Metal Hydroxide	proprietary data		30.268	mg		
			Supplier	Carbon Black (C)	1333-86-4		1.932	mg		
			Supplier	Fused Silica (SiO2)	60676-86-0		515.2	mg		
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		64.4	mg		
			Supplier	Phenolic Resin (Novolac)	9003-35-4		32.1999	mg		
Plating	42.4	mg	Supplier	Tin (Sn)	7440-31-5		42.4	mg		
Wire Bond - Cu	0.15	mg	Supplier	Copper (Cu)	7440-50-8		0.15	mg		

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3